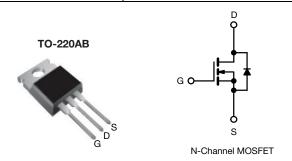
Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | |
|--------------------------|------------------------------|--|--|--|
| V _{DS} (V) | 200 | | | |
| $R_{DS(on)}(\Omega)$ | V _{GS} = 5.0 V 0.18 | | | |
| Q _g max. (nC) | 66 | | | |
| Q _{gs} (nC) | 9.0 | | | |
| Q _{gd} (nC) | 38 | | | |
| Configuration | Single | | | |



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | |
|----------------------|------------|--|
| Package | TO-220AB | |
| Load (Dh) froe | IRL640PbF | |
| Lead (Pb)-free | SiHL640-E3 | |
| SnPb | IRL640 | |
| SIIPD | SiHL640 | |

| ABSOLUTE MAXIMUM RATINGS (T _C : | = 25 °C, unl | ess otherwis | se noted) | | |
|--|--|---|-----------------|-------|----------|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | | V _{DS} | 200 | |
| Gate-Source Voltage | | V _{GS} | ± 10 | V | |
| Continuous Dunin Comment | V -+ 5 0 V | $T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$ | | 17 | |
| Continuous Drain Current V _G | | T _C = 100 °C | I _D | 11 | Α |
| Pulsed Drain Current ^a | | I _{DM} | 68 | | |
| Linear Derating Factor | | | 1.0 | W/°C | |
| Single Pulse Avalanche Energy b | | E _{AS} | 580 | mJ | |
| Repetitive Avalanche Current ^a | | I _{AR} | 10 | А | |
| Repetitive Avalanche Energy ^a | | E _{AR} | 13 | mJ | |
| Maximum Power Dissipation | ximum Power Dissipation T _C = 25 °C | | P _D | 125 | W |
| Peak Diode Recovery dV/dt c | | | dV/dt | 5.0 | V/ns |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | - °C | |
| Soldering Recommendations (Peak temperature) ^d for 10 s | | | 300 | | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in |
| Mounting Torque | | | | 1.1 | N⋅m |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=3.0 mH, $R_q=25$ Ω $I_{AS}=17$ A (see fig. 12). c. $I_{SD}\leq17$ A, $dI/dt\leq150$ A/ms, $V_{DD}\leq V_{DS}$, $T_J\leq150$ °C.

- d. 1.6 mm from case.



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | - | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 1.0 | | |

| PARAMETER | SYMBOL | TEST | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|--|----------|-----------|----------|------------------|
| Static | | | | | Į. | ļ. | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0$ | V, I _D = 250 μA | 200 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | to 25 °C, I _D = 1 mA | - | 0.27 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V$ | ' _{GS} , I _D = 250 μA | 1.0 | - | 2.0 | V |
| Gate-Source Leakage | I _{GSS} | V | _{GS} = ± 10 | - | - | ± 100 | nA |
| Zava Oata Valta va Dusia Ozumant | | $V_{DS} = 2$ | 00 V, V _{GS} = 0 V | - | - | 25 | μА |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 160 V, V | / _{GS} = 0 V, T _J = 125 °C | - | - | 250 | |
| Dunin Course On Chata Basistana | Б | V _{GS} = 5.0 V | I _D = 10 A ^b | - | - | 0.18 | 0 |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 4.0 V | I _D = 8.5 A ^b | - | - | 0.27 | Ω |
| Forward Transconductance | 9 _{fs} | | 0 V, I _D = 10 A b | 16 | - | _ | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, | | - | 1800 | - | pF |
| Output Capacitance | C _{oss} | V | $V_{DS} = 25 \text{ V}$ | | 400 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1.0 | MHz, see fig. 5 | - | 120 | - | |
| Total Gate Charge | Qg | | | - | - | 66 | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 5.0 V | $I_D = 17 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 b | - | - | 9.0 | nC |
| Gate-Drain Charge | Q _{gd} | 7 | See lig. 6 and 16 | - | - | 38 | 1 |
| Turn-On Delay Time | t _{d(on)} | | | - | 8.0 | _ | |
| Rise Time | t _r | $V_{DD} = 1$ | 00 V, I _D = 17 A | - | 83 | - | |
| Turn-Off Delay Time | t _{d(off)} | $V_{DD} = 100 \text{ V}, I_D = 17 \text{ A}$ - 83 - 83 - 84 - 85 - 84 - 85 - 85 - 85 - 85 - 85 | | - | ns | | |
| Fall Time | t _f | | | - | 52 | - | 1 |
| Internal Drain Inductance | L_D | Between lead, 6 mm (0.25") from | | - | 4.5 | - | |
| Internal Source Inductance | L _S | package and ce die contact | enter of | - | 7.5 | - | - nH |
| Gate Input Resistance | Rq | f = 1 M | Hz, open drain | 0.3 | - | 1.2 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbo | ol (| - | - | 17 | ^ |
| Pulsed Diode Forward Current ^a | I _{SM} | integral reverse p - n junction di | 1 (1:. 4\ F | | - | 68 | A |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I | _S = 17 A, V _{GS} = 0 V ^b | - | - | 2.0 | V |
| Body Diode Reverse Recovery Time | t _{rr} | - 310 47 | | 470 | ns | | |
| Body Diode Reverse Recovery Charge | Q _{rr} | $T_J = 25 ^{\circ}\text{C}$, $I_F = 17 \text{A}$, $dI/dt = 100 \text{A/µs}^{\text{b}}$ $\frac{1}{2} ^{\circ}$ $\frac{310}{2}$ | | 4.8 | μC | | |
| Forward Turn-On Time | t _{on} | Intrinsic turn | -on time is negligible (turn | on is do | ninated b | v Le and | L _D) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

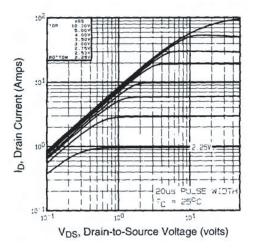


Fig. 1 - Typical Output Characteristics, T_C = 25 $^{\circ}C$

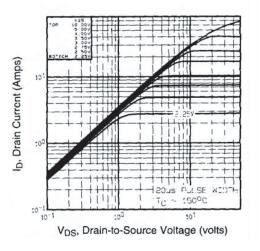


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

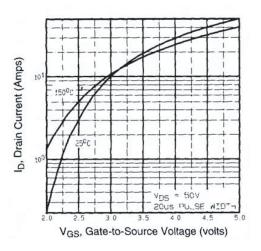


Fig. 3 - Typical Transfer Characteristics

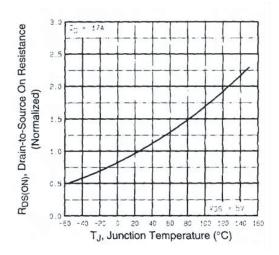


Fig. 4 - Normalized On-Resistance vs. Temperature



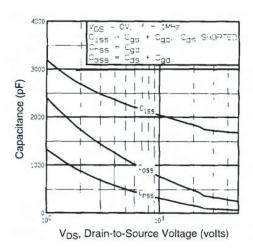


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

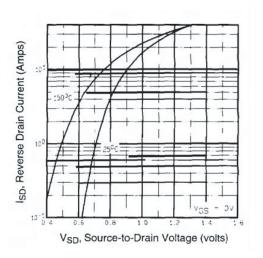


Fig. 7 - Typical Source-Drain Diode Forward Voltage

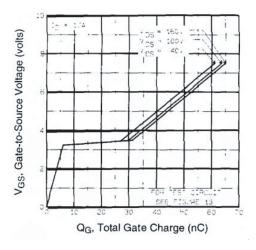


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

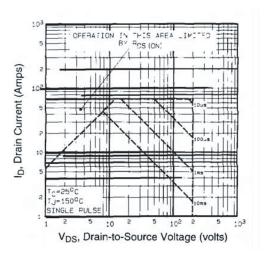


Fig. 8 - Maximum Safe Operating Area



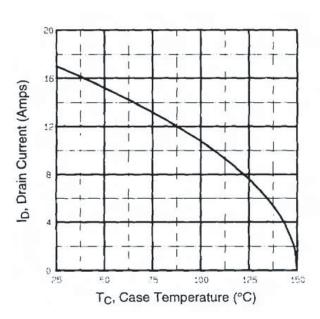


Fig. 9 - Maximum Drain Current vs. Case Temperature

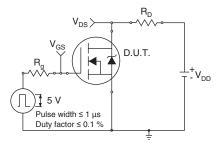


Fig. 10a - Switching Time Test Circuit

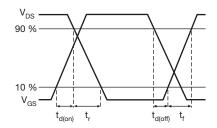


Fig. 10b - Switching Time Waveforms

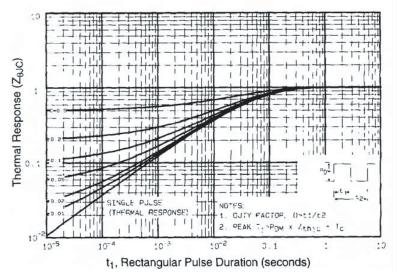


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

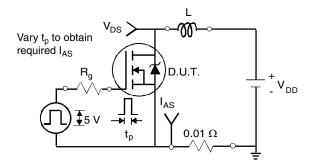


Fig. 12a - Unclamped Inductive Test Circuit

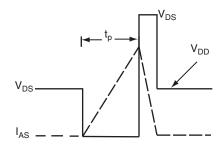


Fig. 12b - Unclamped Inductive Waveforms



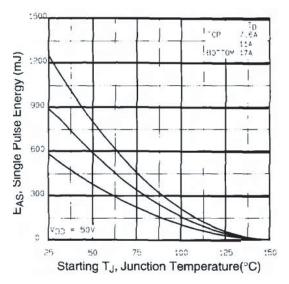


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

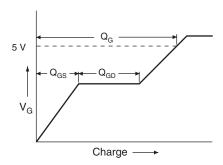


Fig. 13a - Basic Gate Charge Waveform

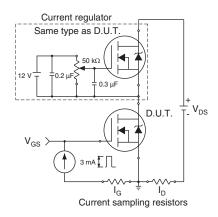
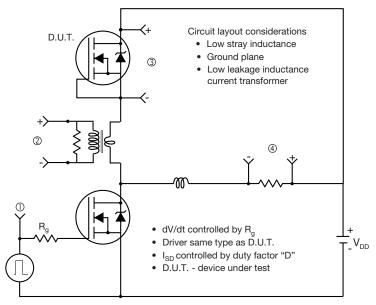


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



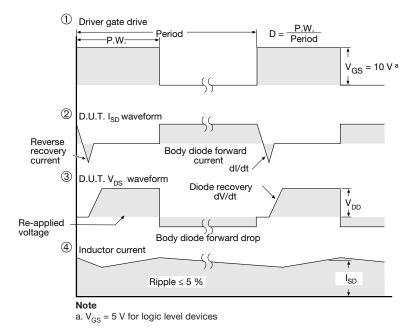


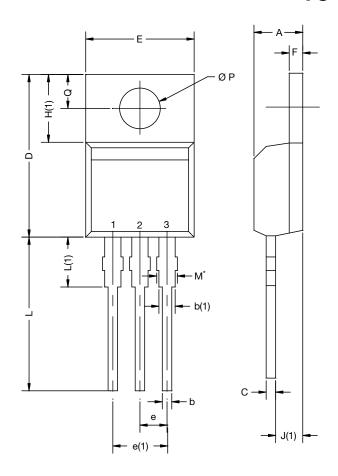
Fig. 14 - For N-Channel

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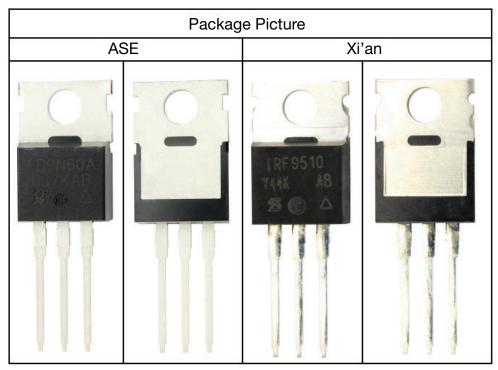
TO-220-1



| DIM. | MILLIN | METERS | INCHES | | |
|------|--------|--------|--------|-------|--|
| | MIN. | MAX. | MIN. | MAX. | |
| Α | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| Е | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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